

FEB 03 2007

Express Mail Label No.: None

INFORMATION
DISCLOSURE
CITATION

Applicant: Hiroshi SEKIYA

S/N: 10/522 648

Conf. No.: 7545

Group: 3752

Filed: September 12, 2005

Atty. Docket No.: 4414.P0668US

Date: January 31, 2007

U.S. PATENT DOCUMENTS

Examiner Initials*	Cite No.	Document Number - Kind Code	Publication Date MM-DD-YYYY	Name of Patentee or Applicant
	AA	5 413 314	05-09-1995	PLATA et al
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	AL	WO 93/01893	02-04-1993	EHRENBERG et al	
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NON PATENT LITERATURE DOCUMENTS

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	AQ	
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EXAMINER SIGNATURE

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